11-21-2005



U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

103122013

To the Director of the U.S. Patent and Trademark Office: Plea	se record the attached documents or the new address(es) below.			
1. Name of conveying party(ies)	2. Name and address of receiving party(ies) O			
Mauralina M. Dirmum Jacken Debrane Moura E. Seltzer P.	Name: Sun Microsystems, Inc.	₹3		
Marcelino M. Dignum, Jochen Behrens, Wayne F. Seltzer & William T. Zaumen	Internal Address: MS SCA12-203	8		
	9	27		
Additional name(s) of conveying party(ies) attached? Yes ✓ No	32	11/2		
3. Nature of conveyance/Execution Date(s):	Street Address: 4150 Network Circle	_		
Execution Date(s) November 4 and November 8, 2005				
Assignment Merger		_		
Security Agreement Change of Name	City: Santa Clara			
Joint Research Agreement	State: CA	_		
Government Interest Assignment	7.05551			
Executive Order 9424, Confirmatory License	Country: USA Zip: 95054	—		
Other	Additional name(s) & address(es) attached? Yes	No		
4. Application or patent number(s):	document is being filed together with a new application			
A. Patent Application No.(s)	B. Patent No.(s)	•		
` ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' ' '				
Additional numbers a	ttached? Yes No			
5. Name and address to whom correspondence	6. Total number of applications and patents			
concerning document should be mailed:	involved: 1			
Name: Daniel Vaughan	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40			
Internal Address:	Authorized to be charged by credit card			
	✓ Authorized to be charged to deposit account			
Street Address: 39180 Liberty Street, Suite 103	✓ Enclosed			
	None required (government interest not affecting title)			
City: Fremont	8. Payment Information			
	a. Credit Card Last 4 Numbers 6514			
State: CA Zip: 94538	Expiration Date <u>05/07</u>			
Phone Number: <u>510-790-9960</u>	b. Deposit Account Number 50-1801			
Fax Number: <u>510-790-9964</u>		—		
Email Address: dan@parklegal.com	Authorized User Name Daniel Vaughan			

9. Signature: November 14, 2005 Signature Date

Total number of pages including cover Daniel Vaughan sheet, attachments, and documents:

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

11/16/2005 MBIZUNES 00000098 11272843

05 FC:8021

40.00 OP

Name of Person Signing

JOINT TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

(1) DIGNUM, Marcelino M. 518 Bay Road Menlo Park, CA 94025 (2) BEHRENS, Jochen 224 Arbor Avenue Santa Cruz, CA 95062

(3) SELTZER, Wayne F. 1613 Elmar Way San Jose, CA 95129 (4) ZAUMEN, William T. 912 Clara Drive Palo Alto, CA 94303

hereinafter termed "Inventors", have invented certain new and useful improvements in

HARDWARE UNIT FOR PARSING AN XML DOCUMENT

and have executed a declaration or oath of inventorship for an application for a United States patent disclosing and identifying the invention on:

(1) the 4th day of November , 2005; (2) the 4th day of November , 2005; (3) the 4th day of November , 2005; (4) the 8th day of November , 2005.

Said application: [X] being filed herewith; OR

[] having Application No. ______, filed on _______, 2005.

WHEREAS, <u>Sun Microsystems</u>, <u>Inc.</u> a corporation of the State of <u>Delaware</u>, having a place of business at <u>4150 Network Circle</u>, <u>Santa Clara</u>, <u>CA 95054</u>, (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

- 1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a divisional, substitution, continuation, or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.
- 2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications,

1 of 2

Attorney Docket No. SUN05-0976

declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

- 3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.
- 4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the dates written below.

Date: 11 4 05	Signature:	O val
		Marcelino M. Dignum
Date:	Signature:	
	Name:	Jochen Behrens
Date: 11/4/05		Wayne F. Seltzer
Date:		William T. Zaman
	name:	William T. Zaumen

2 of 2

JOINT TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned,

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- 2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications,

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declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation reissues and reexaminations, opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

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IN WITNESS WHEREOF, said Inventors have executed and delivered this instrument to said Assignee as of the dates written below.

Date:	Signature:	
	Name:	Marcelino M. Dignum
Date: 11/04/2005	Signature:	J. 18
	Name:	Jochen Behrens
Date:	Signature:	
	Name:	Wayne F. Seltzer
Date:	Signature:	
	Name:	William T. Zaumen

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(3) the	4th day of	Novem	ber, 2005;	(4)	the <u>8th</u> day of _	November	, 2005
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		[]	having Application N	No	, filed on		, 2005

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Date:	Signature:	
	Name:	Jochen Behrens
Date:	Signature:	
	Name:	Wayne F. Seltzer
Date: Nev 8 2005	Signature: <u>W</u>	illian T. Zaunes
		William T. Zaumen

2 of 2

Attorney Docket No. SUN05-0976

RECORDED: 11/14/2005